

CRYSTAL OSCILLATOR (SPXO)

OUTPUT: HCSL





Product Number X1G005141xxxx00

SG3225HBN

100 MHz to 325 MHz 2.5V, 3.3 V •Frequency range •Supply voltage

Output HCSL

 Function Output enable (OE) 3.2 × 2.5 × 1.05 mm 85 fs Typ (fo = 156.25MHz) External dimensions Phase jitter







Specifications	<u>(cnarac</u>	teristics)			
Item	Symbol	Specifications	Conditions / Remarks Please contact us for inquiries regarding available frequencies.		
Output frequency range	fo	100 MHz to 325 MHz			
Supply voltage	V_{CC}	D : $2.5 \text{ V} \pm 0.125 \text{ V}$, C : $3.3 \text{ V} \pm 0.165 \text{ V}$			
Storage temperature	T_stg	-55 °C to +125 °C	Store as bare product.		
Operating temperature	T_use	G: -40 °C to +85 °C, H: -40 °C to +105 °C			
Frequency tolerance	f_tol	J: ± 50 × 10 ⁻⁶ (Not available H : -40 °C to +105 °C) L: ± 100 × 10 ⁻⁶	Includes initial frequency tolerance, temperature variation, supply voltage change and 10 years aging(+25 °C)		
Current consumption	Icc	25 mA Typ. 35 mA Max.	OE= V _{CC} , with output load		
Disable current	I_dis	15 mA Max.	OE=GND		
Symmetry	SYM	45 % to 55 %	At outputs crossing point		
Output voltage $\frac{V_0}{V_0}$		0.75 V Typ., 0.66 V to 0.85 V 0 V Typ., -0.15 V to 0.15 V	DC characteristics, single output		
Crossing voltage	VcR	0.25 V to 0.55 V			
Output load condition	L_HCSL	50 Ω			
	Rs	33 Ω			
Input voltage	VIH	70 % V _{CC} Min.	OE terminal		
	VIL	30 % V _{CC} Max.	OE terminal		
differential output rise slew rate	Rr / Rf	1 V/ns to 4 V/ns	Between -0.15 V and 0.15 V of differential output		
Start-up time	t_str	10 ms Max.	Time at minimum supply voltage to be 0 s		

Phase Jitter

	Output frequency	100 MHz	125 MHz	156.25 MHz	200 MHz	322.265625 MHz	Supply voltage
Phase Jitter [fs]	Тур.	110	95	85	75	65	V _{cc} =3.3V±0.165V
(Offset Frequency 12k to 20MHz)	Max.	180	160	140	125	110	VCC-3.3V±0.103V

Product Name (Standard form)

2.50±0.20

SG3225 HBN 156.250000MHz C J G A

<u>1,05±0.15</u>

(56: Not Available code JH)

(Unit:mm)

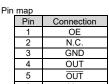
3 (1) (4)(5)(6)(7)

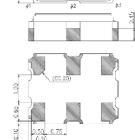
①Model ②Output (H: HCSL) ③Frequency ④Supply voltage (D: 2.5 V Typ. , C: 3.3 V Typ.)

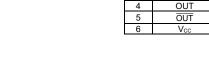
 \odot Frequency tolerance (J: $\pm 50 \times 10^{-6}$ L: $\pm 100 \times 10^{-6}$)

⑥Operating temperature (G:-40 to +85°C, H:-40 to +105°C) ⑦Internal identification code("A" is default)

External dimensions







Note: OE pin = HIGH or "Open" : Specified frequency output. OE pin = LOW: Output is high impedance

0.92 1.05 .85 2.58

(Unit:mm)

Footprint (Recommended)

In order to achieve optimum jitter performance, it is recommended that the capacitor $(0.1 \mu F + 10 \mu F)$ between V_{CC} and GND pin should be placed as close to the V_{CC} pin as possible.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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